

# Hao Xue

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## SUMMARY

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### Research & Industry Experience:

6-year industry experience as a hardware verification engineer mainly focusing on *formal verification* (4 years);  
4-year college teaching experience (2-year as Teaching Assistant to teach labs, 2-year as Adjunct Faculty to teach course & lab);  
6-year graduate research experience in *hardware security*, *VLSI design optimization* (published 7 journal papers and 6 conference proceedings).

**Programming:** Verilog, VHDL, SystemVerilog, PSL, Tcl, Python, Shell.

**Tools:** Cadence Virtuoso/JasperGold, Synopsys VCS/PrimePower/TetraMax, Ansys PowerArtist, OneSpin, Xilinx Vivado.

**Version Control:** SVN, Git.

## EDUCATION

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### Wright State University, Dayton, OH

- **Ph.D.**, Engineering, 2018 (Graduate Student Excellence Awards)
  - Dissertation: *Hardware Security and VLSI Design Optimization*
- **M.S.Egr.**, Electrical Engineering, 2013
  - Thesis: *Timing and Power Optimization using Mixed-Dynamic-Static CMOS*

## WORK EXPERIENCE

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### Intel Corporation

Formal Verification Engineer

Portland, OR  
01.2022 – Present

- Hands-on experience on verification plan, tests, debug, coverage analysis and project execution.
- Apply Formal Methods Techniques for verifying algorithms, protocols and their RTL implementations in domains such as Caches, Mesh, PCIe etc.

### Wright State University, Department of Electrical Engineering

Adjunct Faculty (part-time)

Dayton, OH  
01.2019 – 04.2022

- Create/teach course/lab: IC Hardware Security & Trust.

### Edaptive Computing Inc

Digital Verification Engineer

Dayton, OH  
09.2018 – 12.2021

- Hardware verification using side-channel analysis, formal verification, etc.

## SERVICE

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### Military Service

U.S. Army Reserve, Unit Supply Specialist

09.2015 – 09.2021  
Cincinnati, OH

- Maintain automated supply system for accounting of organizational and installation supplies and equipment.

### Professional Service

- Reviewer, *IEEE Transactions on Components, Packaging, and Manufacturing Technology*
- Reviewer, *International Journal of Electronics*.
- Reviewer, *IEEE Transactions on Very Large Scale Integration Systems*.
- Reviewer, *Microelectronics Journal*.
- Reviewer, *IEEE Letters of the Computer Society*.
- Reviewer, *IEEE International Symposium on Circuits and Systems (ISCAS)*.

## AWARDS

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| Title of Award                          | Granting Association                 | Dates   |
|---|--------------------------------------|---------|
| FV quality Freak-out bug Award          | Intel Corporation                    | 12.2022 |
| Graduate Student Excellence Awards      | Wright State University              | 04.2019 |
| IEEE Dayton Section Outstanding Student | IEEE Dayton Section                  | 04.2018 |
| Certificate of Achievement              | United States Department of the Army | 10.2017 |